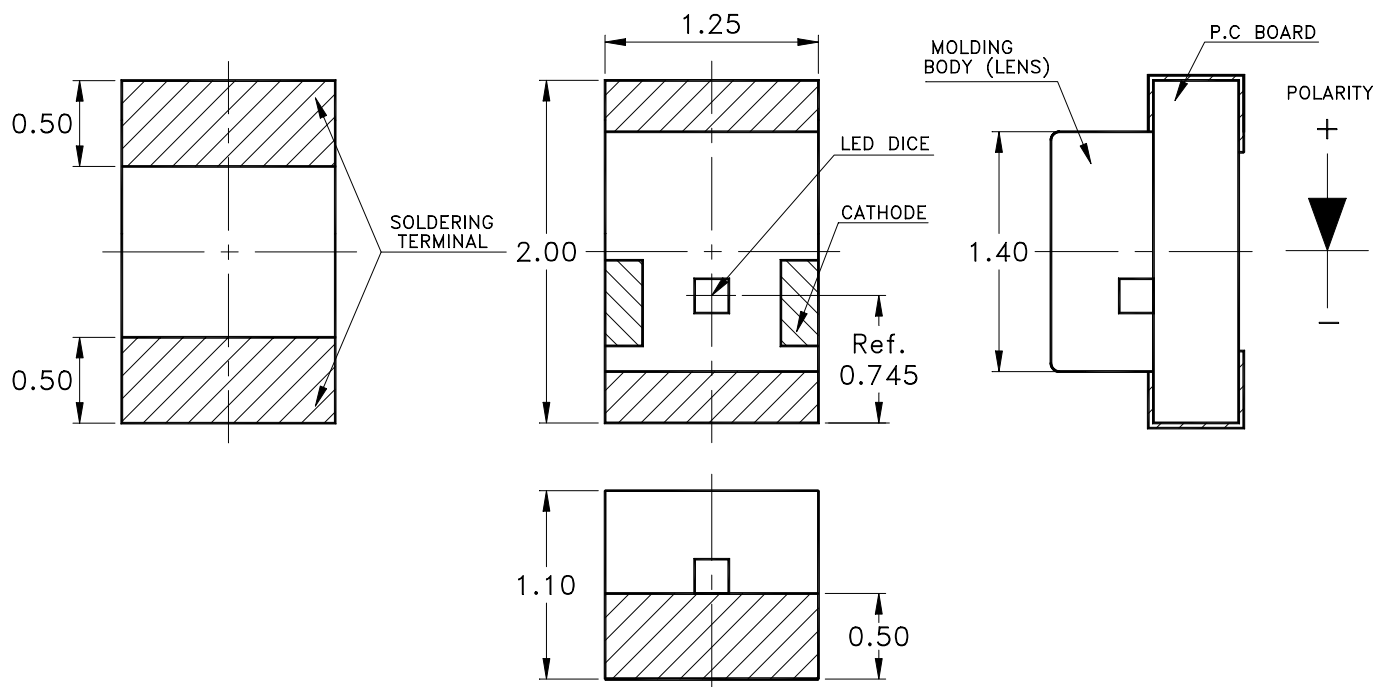


Features

- * Meet ROHS, Green Product.
- * Package In 8mm Tape On 7" Diameter Reels.
- * Compatible With Automatic Placement Equipment.
- * Compatible With Infrared And Vapor Phase Reflow Solder Process.
- * EIA STD package.
- * I.C. compatible.

Package Dimensions



Part No.	Lens	Source Color
LTST-C170AKT	Water Clear	GaAsP on GaP Orange

Notes:

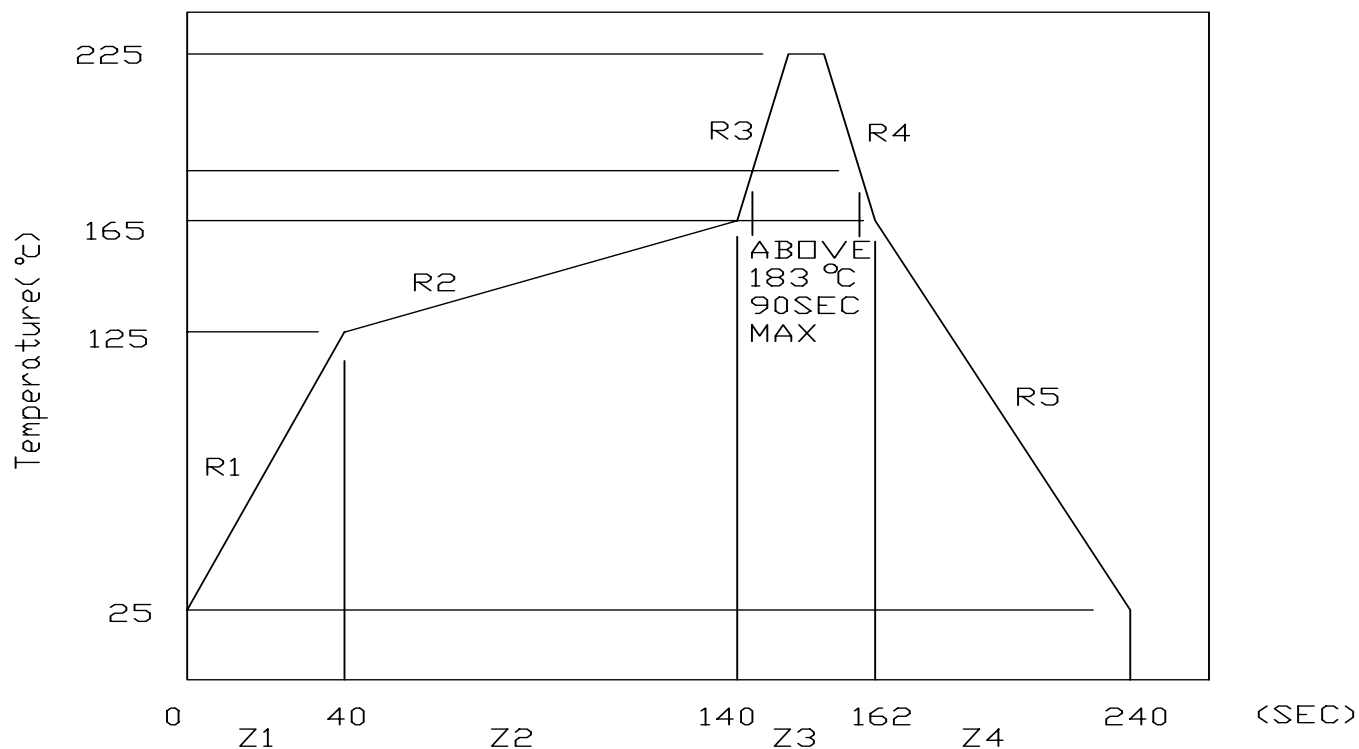
1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.10 mm (.004") unless otherwise noted.

Absolute Maximum Ratings At Ta=25°C

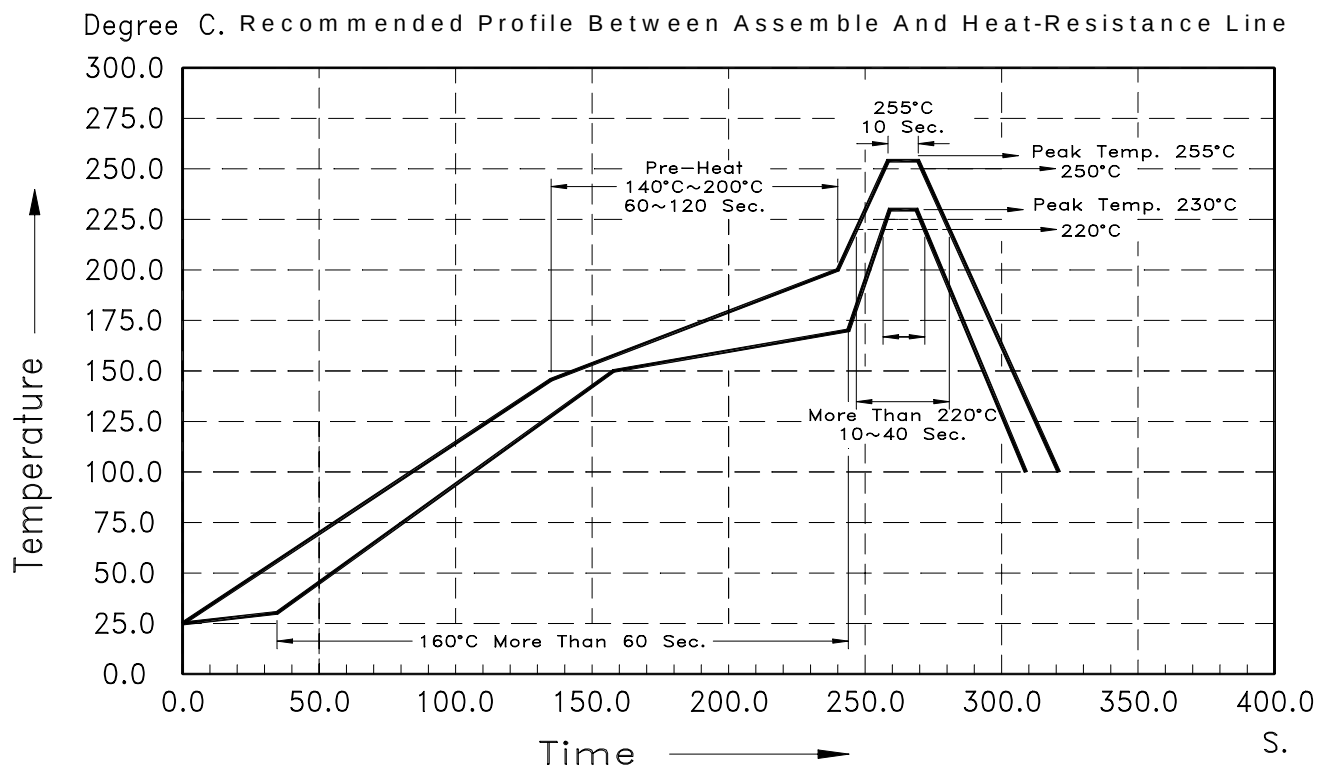
Parameter	LTST-C170AKT	Unit
Power Dissipation	100	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	120	mA
DC Forward Current	30	mA
Derating Linear From 50°C	0.6	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-55°C to + 85°C	
Storage Temperature Range	-55°C to + 85°C	
Wave Soldering Condition	260°C For 5 Seconds	
Infrared Soldering Condition	260°C For 5 Seconds	
Vapor Phase Soldering Condition	215°C For 3 Minutes	

Suggestion Profile:

(1) Suggestion IR Reflow Profile For Normal Process



(2) Suggestion IR Reflow Profile For Pb Free Process



The Profile is available that must to use SnAg ($x=3.3\sim3.8$) Cu ($y=0.2\sim0.7$) solder paste

Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTST-	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	C170AKT	1.12	2.5		mcd	IF = 10mA Note 1
Viewing Angle	2 θ 1/2	C170AKT		130		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ P	C170AKT		610		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ d	C170AKT		602		nm	Note 3
Spectral Line Half-Width	$\Delta \lambda$	C170AKT		35		nm	
Forward Voltage	VF	C170AKT		2.1	2.6	V	IF = 20mA
Reverse Current	IR	C170AKT			10	μ A	VR = 5V
Capacitance	C	C170AKT		15		PF	VF = 0 f = 1MHZ

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Bin Code List

Luminous Intensity		Unit : mcd @10mA
Bin Code	Min.	Max.
F	1.12	1.80
G	1.80	2.80
H	2.80	4.50
J	4.50	7.10
K	7.10	11.2

Tolerance on each Intensity bin is +/-15%

Typical Electrical / Optical Characteristics Curves

(25 °C Ambient Temperature Unless Otherwise Noted)

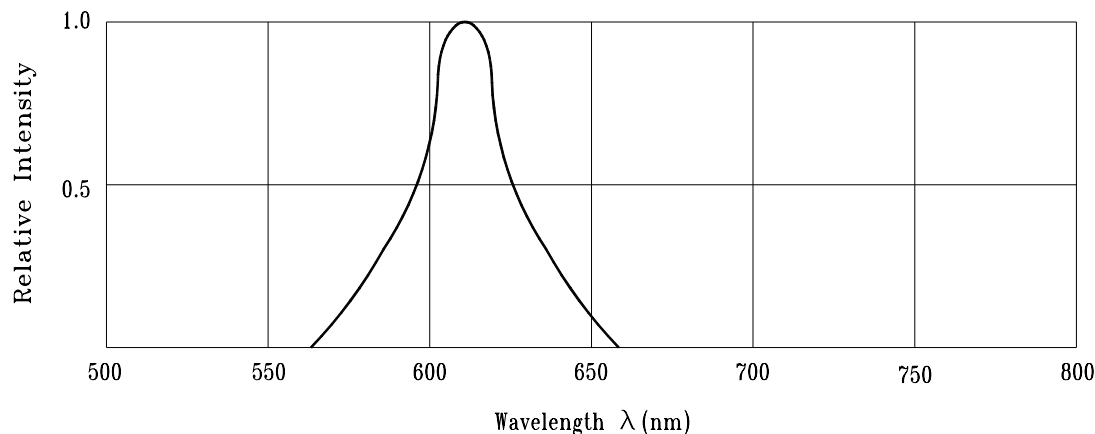


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

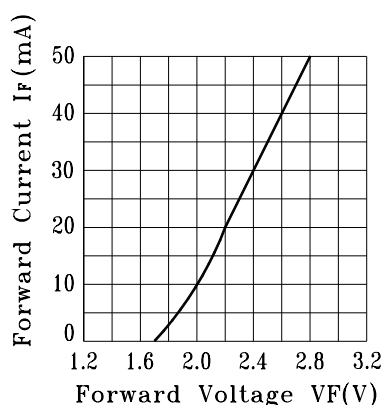


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

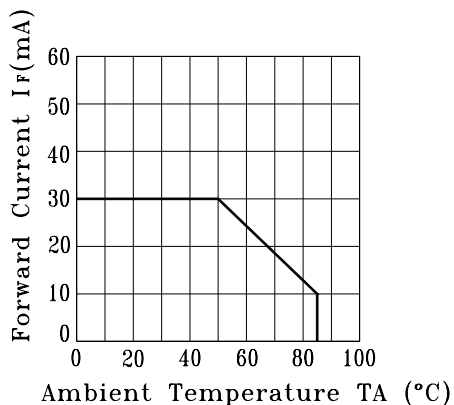


Fig.3 FORWARD CURRENT DERATING CURVE

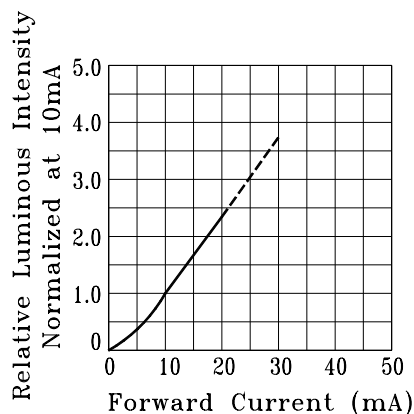


Fig.4 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

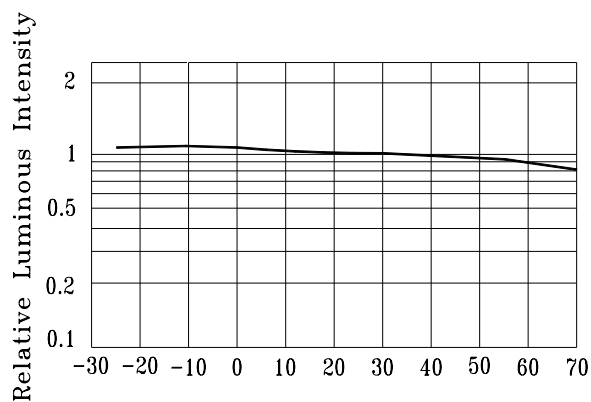


Fig.5 LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE.

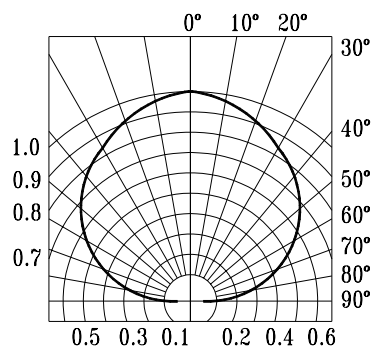


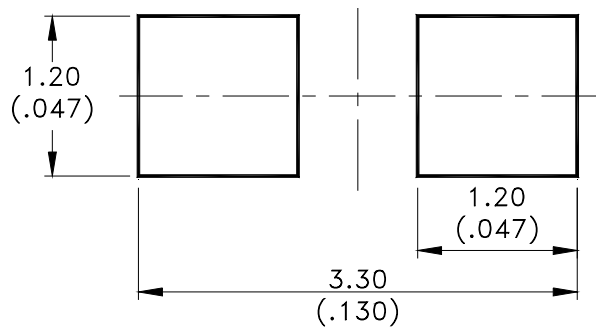
Fig.6 SPATIAL DISTRIBUTION

Cleaning

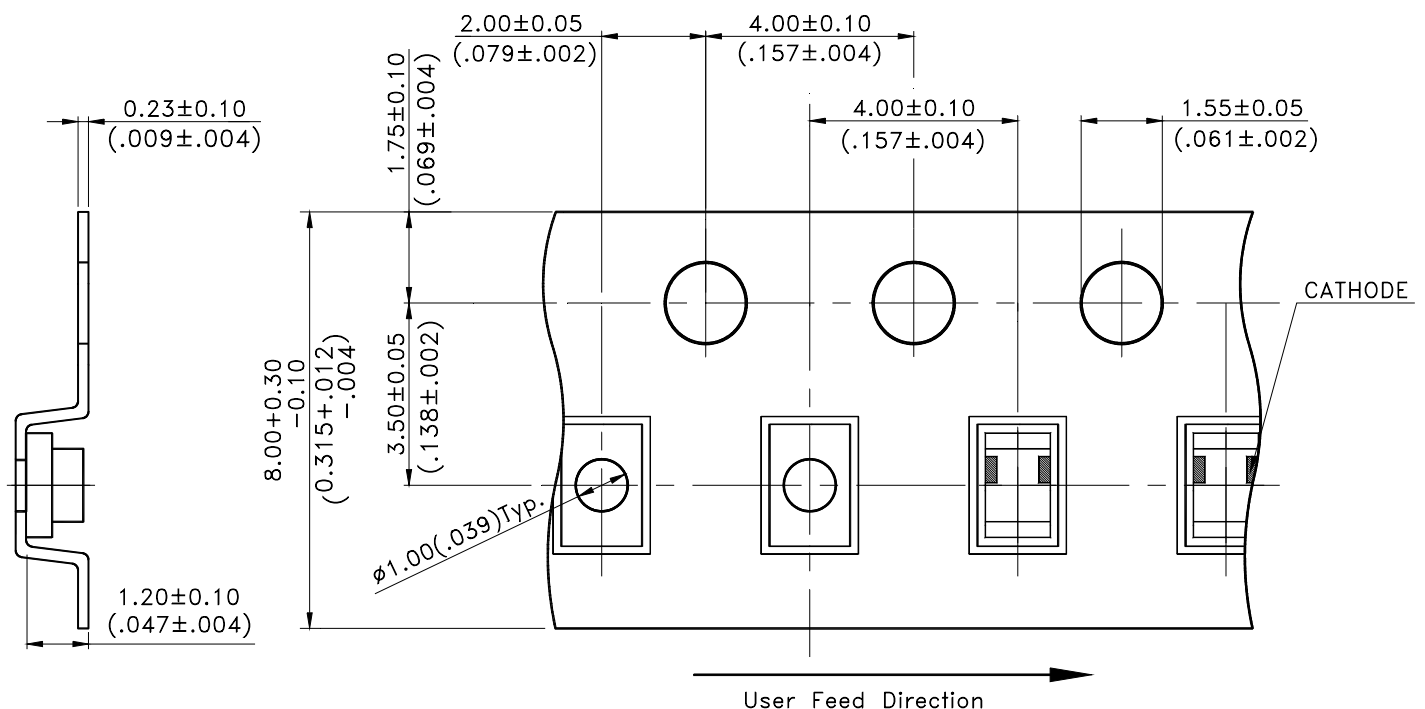
Do not use unspecified chemical liquid to clean LED they could harm the package.

If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

Suggest Soldering Pad Dimensions

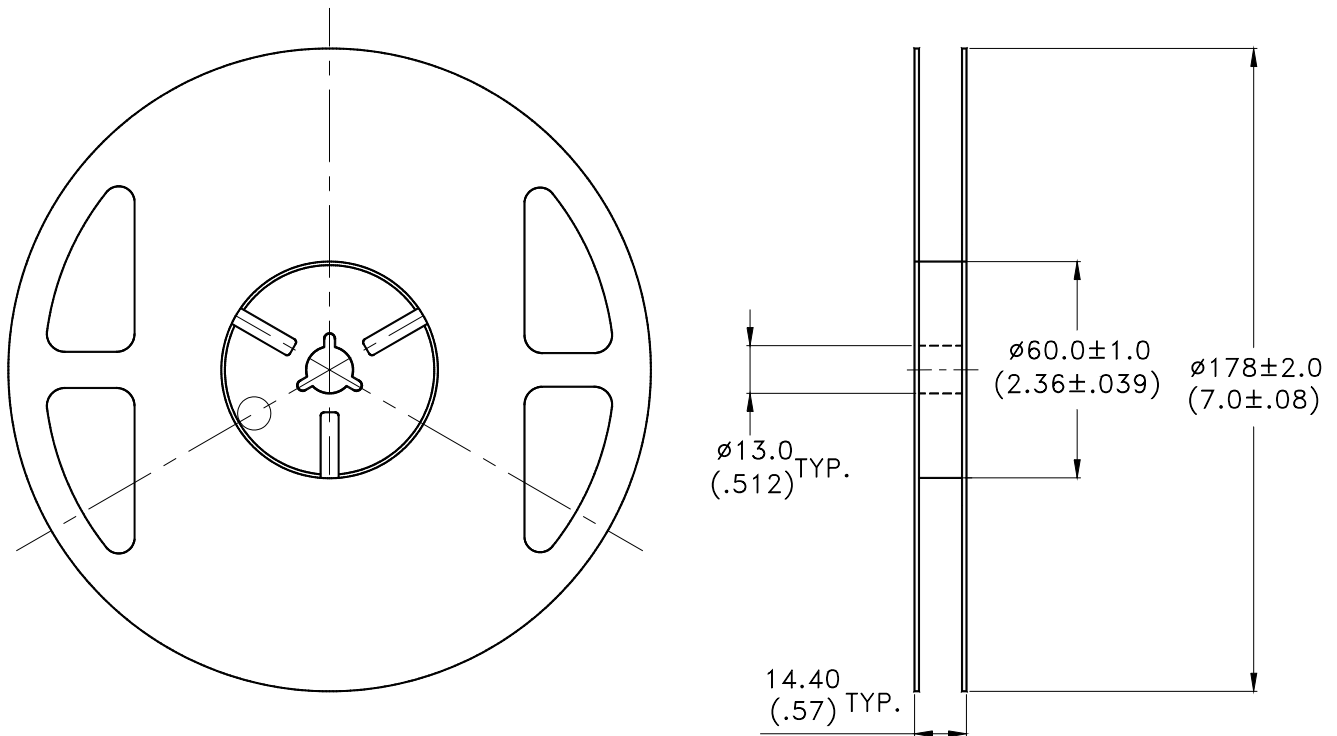


Package Dimensions Of Tape And Reel



Notes:

1. All dimensions are in millimeters (inches).



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-3000 pieces per reel.
3. Minimum packing quantity is 500 pcs for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are IR-reflowed within one week. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient. LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

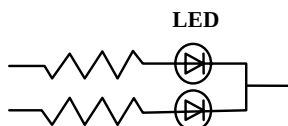
Recommended soldering conditions:

Reflow soldering		Wave Soldering		Soldering iron	
Pre-heat	120~150°C	Pre-heat	100°C Max.	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Pre-heat time	60 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	240°C Max.	Solder wave	260°C Max.		(one time only)
Soldering time	10 sec. Max.	Soldering time	10 sec. Max.		

5. Drive Method

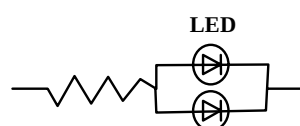
An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



(A) Recommended circuit.

Circuit model B



(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “ no lightup ” at low currents.

To verify for ESD damage, check for “ lightup ” and Vf of the suspect LEDs at low currents.

The Vf of “ good ” LEDs should be $>2.0V@0.1mA$ for InGaN product and $>1.4V@0.1mA$ for AlInGaP product.

7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= $65\pm5^{\circ}C$, RH= 90~95% *Test Time= 240HRS $\pm$ 2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= $105\pm5^{\circ}C$ *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= $-55\pm5^{\circ}C$ *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	$105^{\circ}C \sim 25^{\circ}C \sim -55^{\circ}C \sim 25^{\circ}C$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}C \sim -40^{\circ}C \pm 5^{\circ}C$ 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	T.sol= $260 \pm 5^{\circ}C$ Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	IR-Reflow Normal Process	Ramp-up rate($183^{\circ}C$ to Peak) $+3^{\circ}C$ / second max Temp. maintain at $125(\pm 25)^{\circ}C$ 120 seconds max Temp. maintain above $183^{\circ}C$ 60-150 seconds Peak temperature range $235^{\circ}C +5/-0^{\circ}C$ Time within $5^{\circ}C$ of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate $+6^{\circ}C$ /second max	MIL-STD-750D:2031.2(1995) J-STD-020(1999)
	IR-Reflow Pb Free Process	Ramp-up rate($217^{\circ}C$ to Peak) $+3^{\circ}C$ / second max Temp. maintain at $175(\pm 25)^{\circ}C$ 180 seconds max Temp. maintain above $217^{\circ}C$ 60-150 seconds Peak temperature range $260^{\circ}C +0/-5^{\circ}C$ Time within $5^{\circ}C$ of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate $+6^{\circ}C$ /second max	MIL-STD-750D:2031.2(1995) J-STD-020(1999)
	Solderability	T.sol= $235 \pm 5^{\circ}C$ Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Lite-On:

[LTST-C170AKT](#)

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9